



# **Results with Additive Manufacturing of accelerator components**

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**... and most importantly, the whole AM team of WP10**

# Where we are with task 10.2 so far

Our initial objectives, from I.FAST proposal:

T10.2: Additive Manufacturing. Survey of applications and potential development (M1-M36)

- Survey of current AM applications in accelerators and identification of needs for future development and research actions
- Promote initiatives to identify how AM can address the needs of the accelerator community
- Define strategic directions for future AM technologies and foster their impact on accelerator applications (sterilisation, medicine, industry), identifying technology barrier and challenges

# Survey of AM applications

- IFAST-D10.1 and IFAST-MS44 submitted on end October 2023
- The D10.1 report also contains the output of a questionnaire distributed to the accelerator community
- “Review of metal additive manufacturing for particle accelerator applications”, to be published in Physical Review Accelerators and Beams

## I.FAST

Innovation Fostering in Accelerator Science and Technology  
Horizon 2020 Research Infrastructures GA n° 101004730

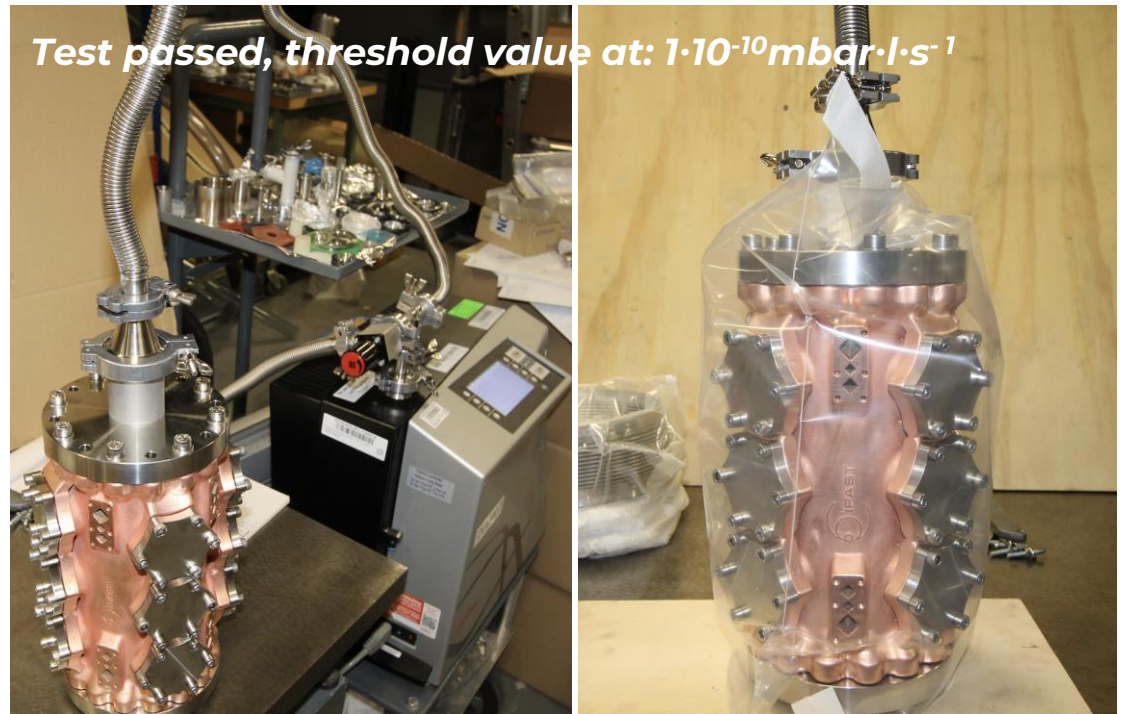
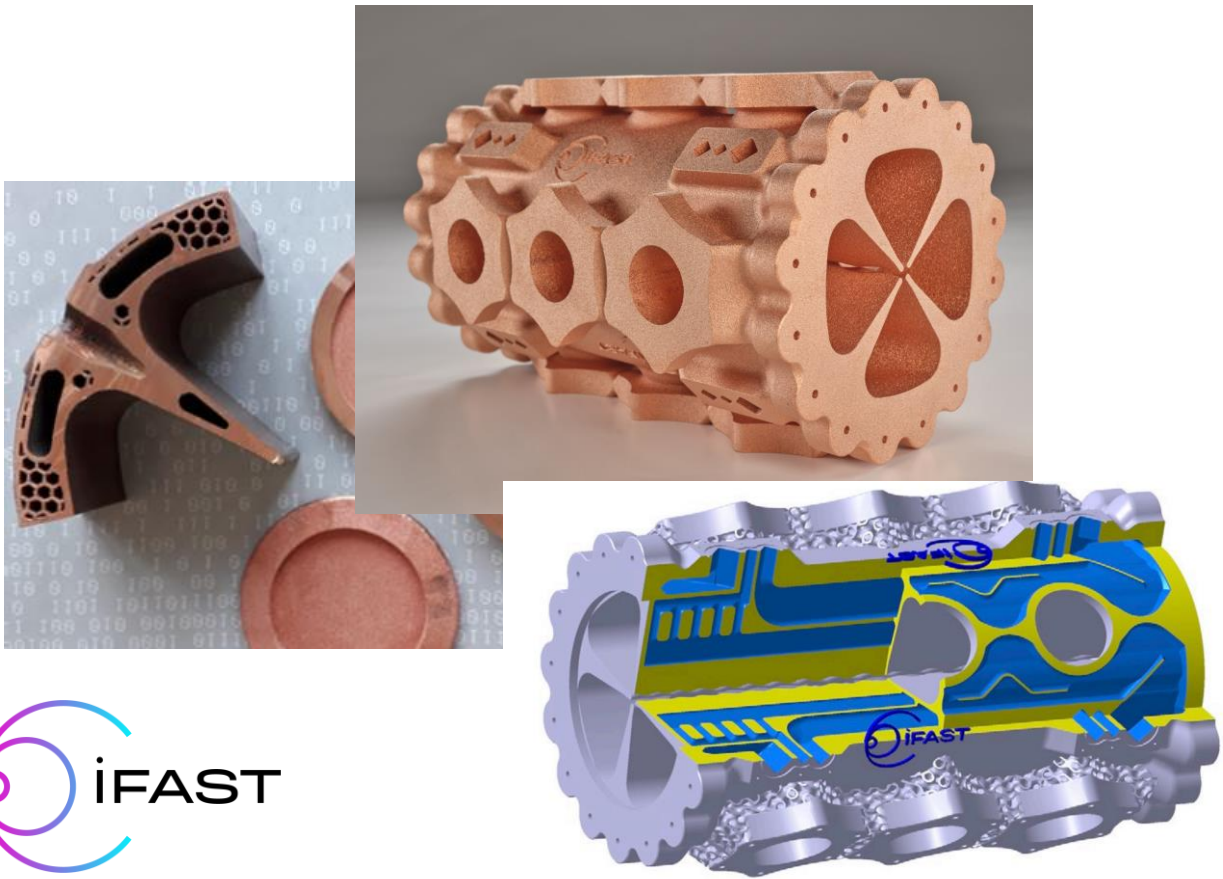
### DELIVERABLE REPORT

#### Potential AM applications in accelerators

DELIVERABLE: D10.1

# RFQ - related activities

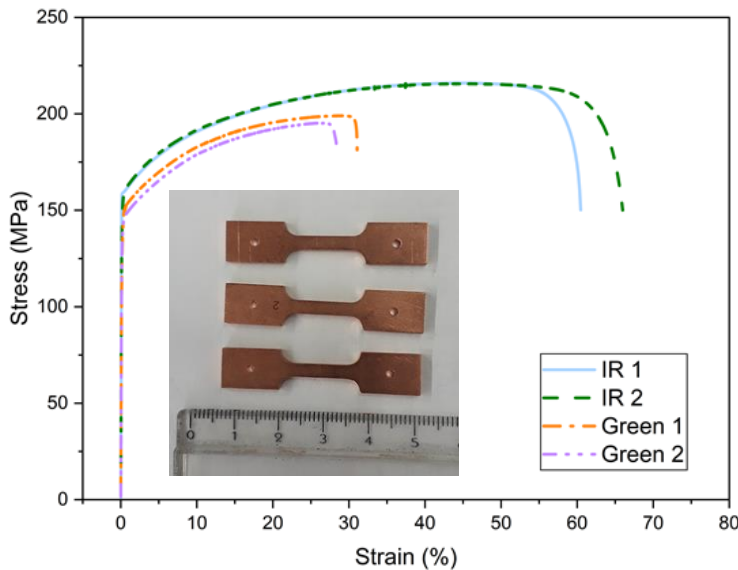
The main demonstrator for WP10, after printing two versions of the full-section RFQ, tests have been done on one of the samples to investigate surface treatments, machining of functional surfaces, He leakage, ...



thanks to CERN TE-VSC, Cedric GARION and Hendrik KOS

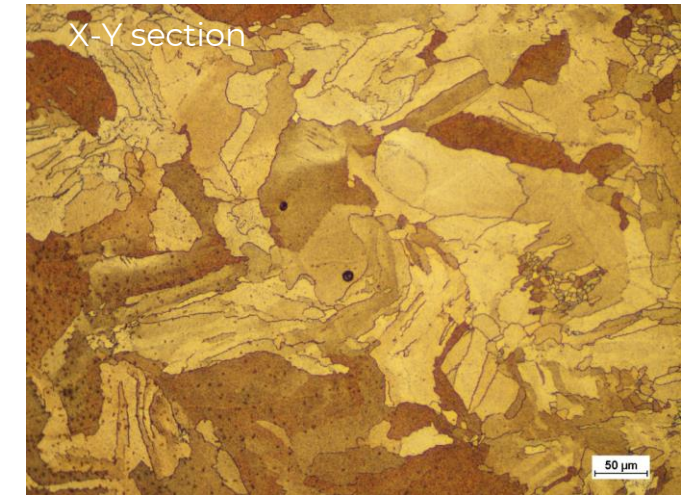
# AM of copper and related properties

Copper has been printed by LPBF technology using both green and IR laser systems, both can provide the expected properties



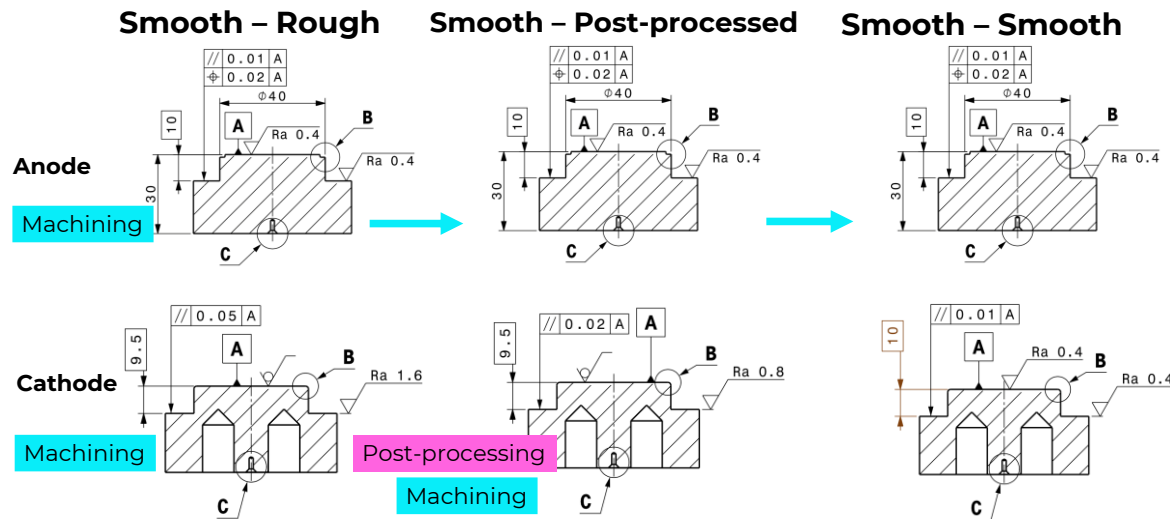
Therm. diffusivity (cm <sup>2</sup> /s @ 21°C)	reference Cu 99,99+%	IR laser BD	Green laser BD	Green laser TD
Average	1,174	1,166	1,172	1,165
%	-	99,32	99,82	99,23
Therm. conductivity (W/mK @ 21°C)	reference Cu 99,99+%	IR laser BD	Green laser BD	Green laser TD
Average	404,08	401,32	403,91	400,98

Electr. conductivity (MS/m @ 25°C)	IR laser BD	IR laser TD	Green laser BD	Green laser TD
Average	57,74	55,57	58,21	57,82
%	99,55	95,81	100,37	99,68
Vickers hardness (HV <sub>0.05</sub> )	IR laser		Green laser	
	78.2 ± 1.9		75.5 ± 3.2	

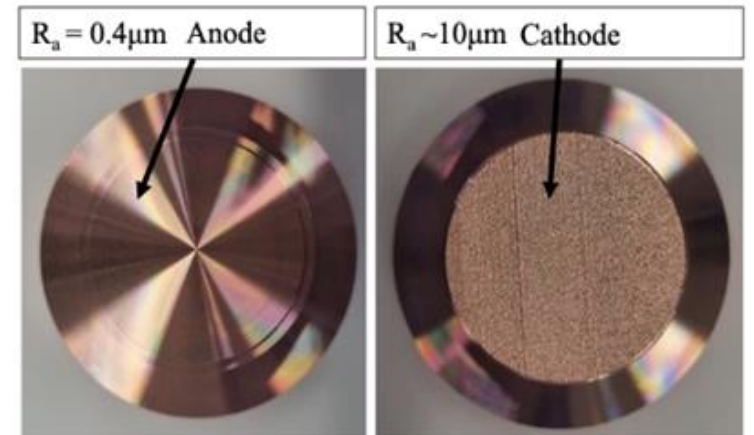
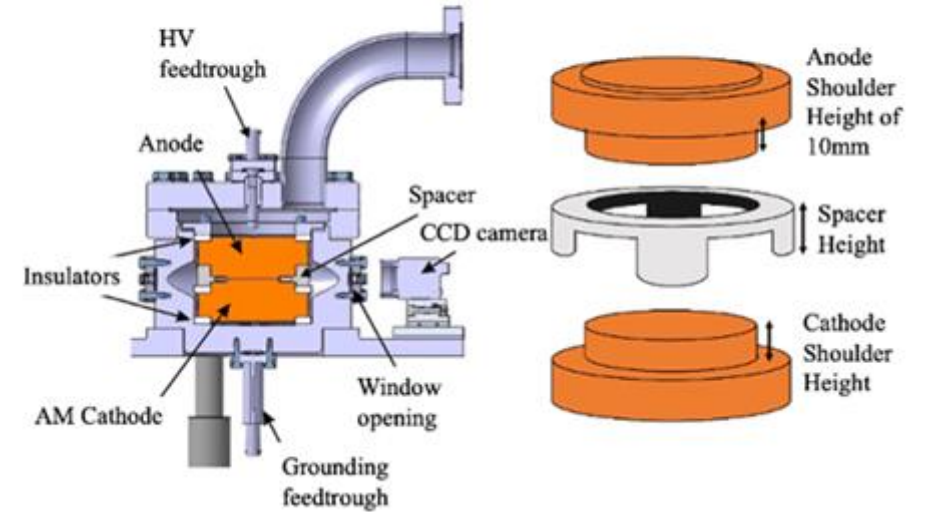


# High-voltage behaviour of AM Copper

Different surface conditions are under investigation



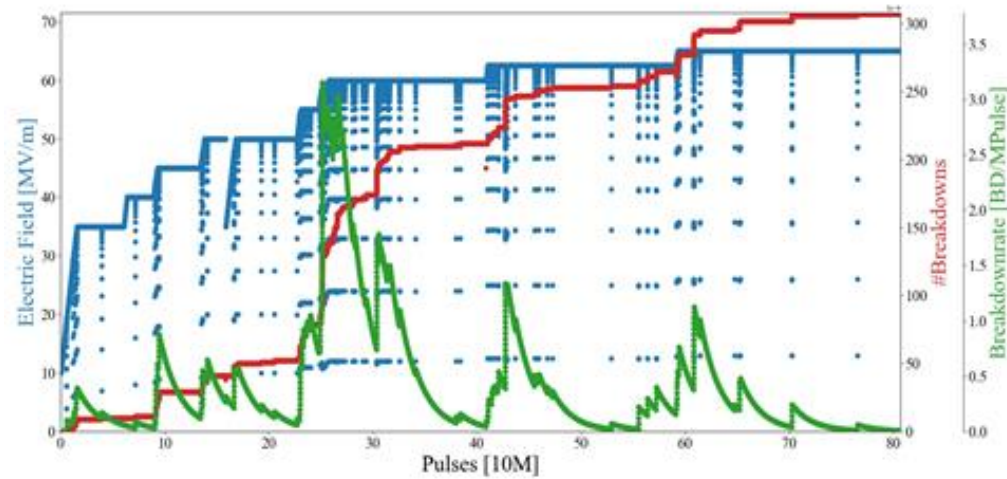
## CERN's pulsed high-voltage DC system



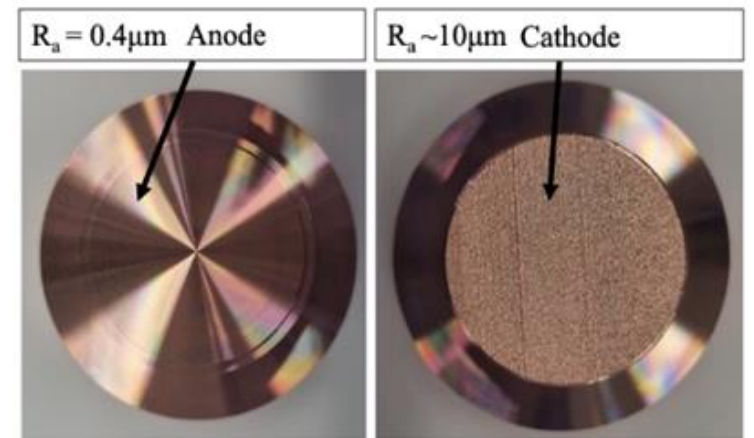
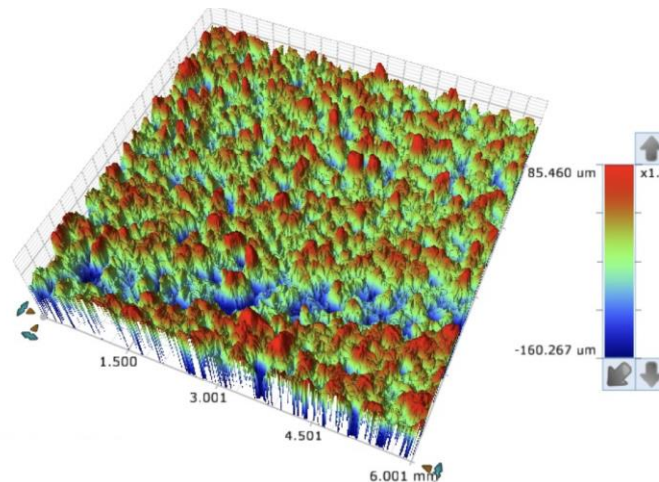
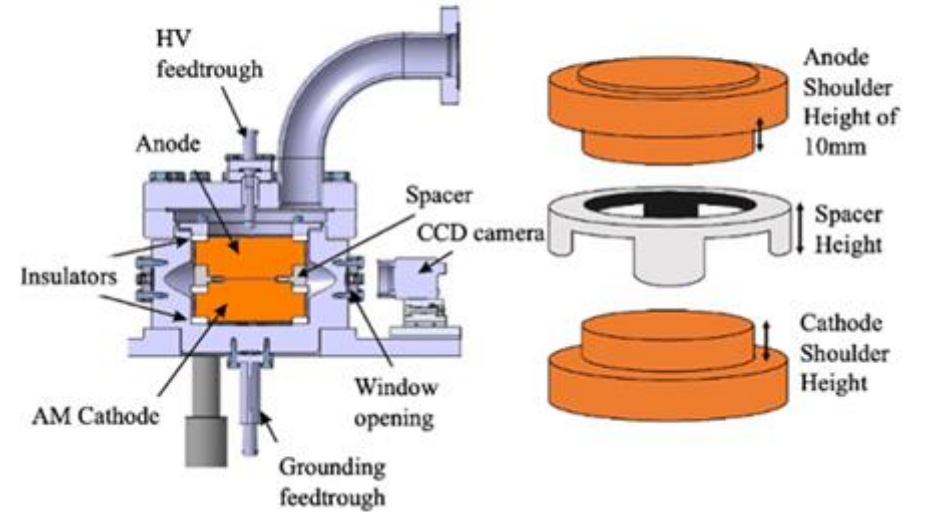
thanks to CERN SY-RF team W. Wuensch and V. Bjelland

# High-voltage behaviour of AM Copper

Different surface conditions are under investigation



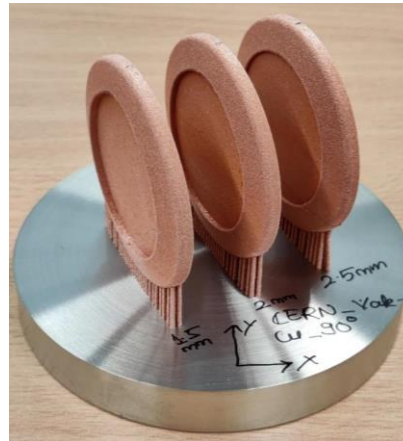
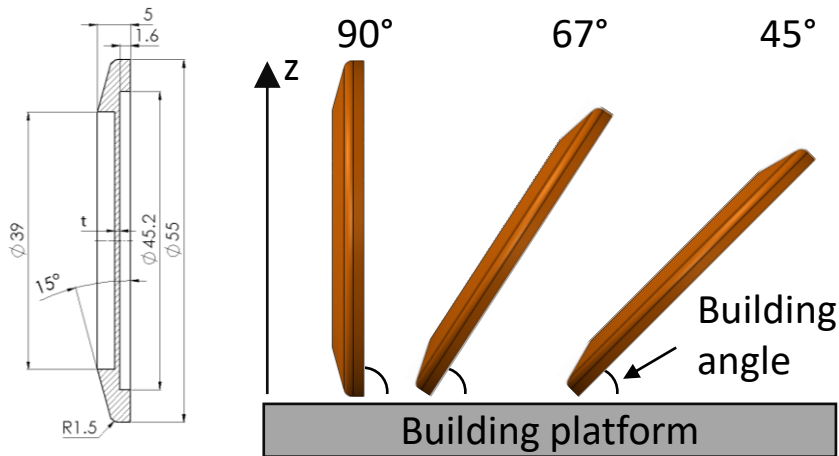
## CERN's pulsed high-voltage DC system



# UHV tests on Cu printed membranes

Standard test membranes printed by a green laser with different thickness and print orientation

- Nominal thickness: 2,5, 5, 1,5, 1, 0,75, 0,5 mm
- Building orientation: 90°, 67°, 45°

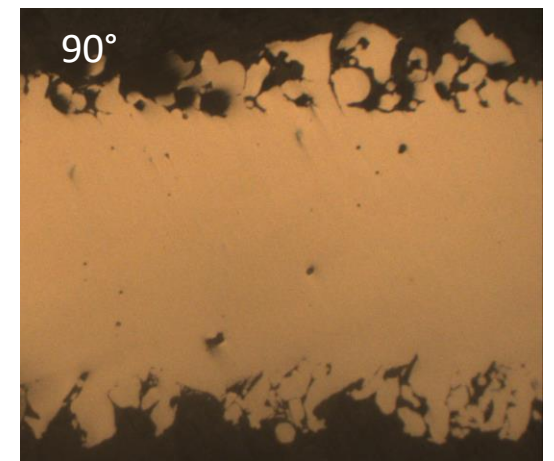
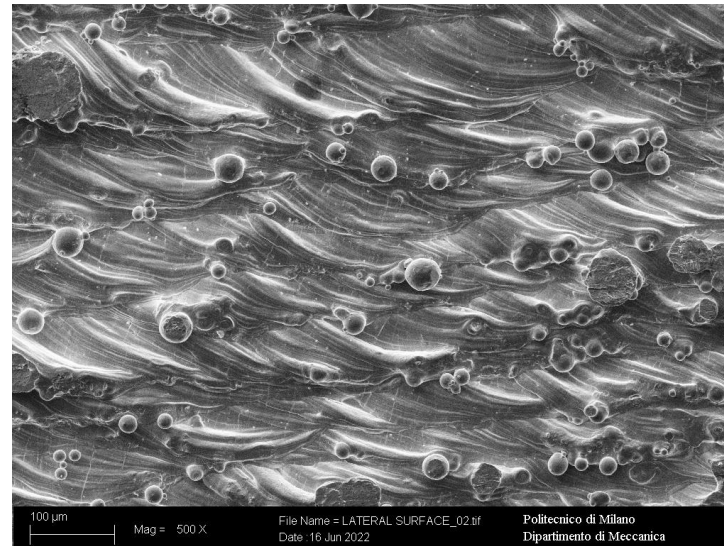




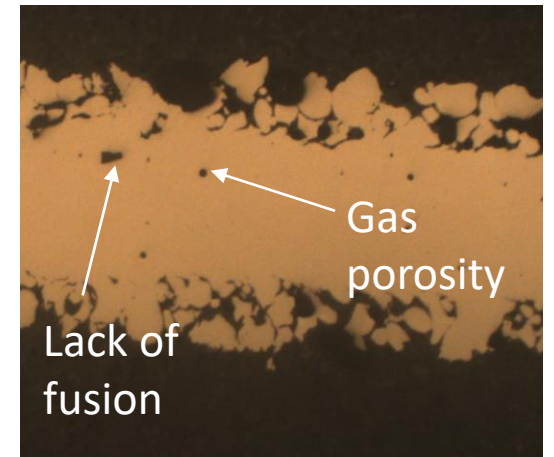
# UHV tests on Cu printed membranes

Only small-thickness membranes at highest angles failed the test due to actual thickness related to roughness

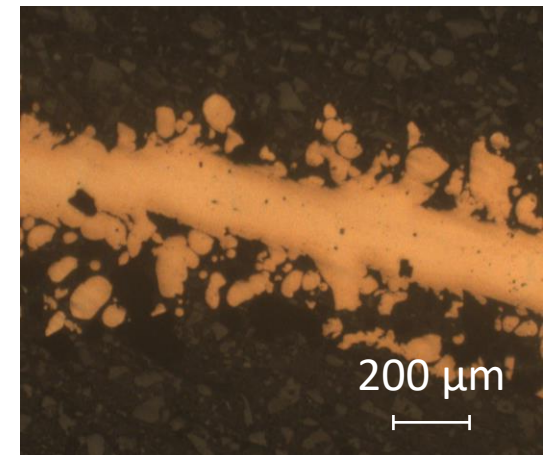
Building angle Nominal thickness (mm)	Helium leak rate (mbar l s <sup>-1</sup> )		
	45°	67°	90°
2.5	PASS	PASS	PASS
2	PASS	PASS	PASS
1.5	PASS	PASS	PASS
1	PASS	PASS	PASS
0.75	PASS	PASS	$1.0 \cdot 10^{-6}$
0.5	PASS	$2.5 \cdot 10^{-3}$	$5.0 \cdot 10^{-2}$



1 mm



0.75 mm

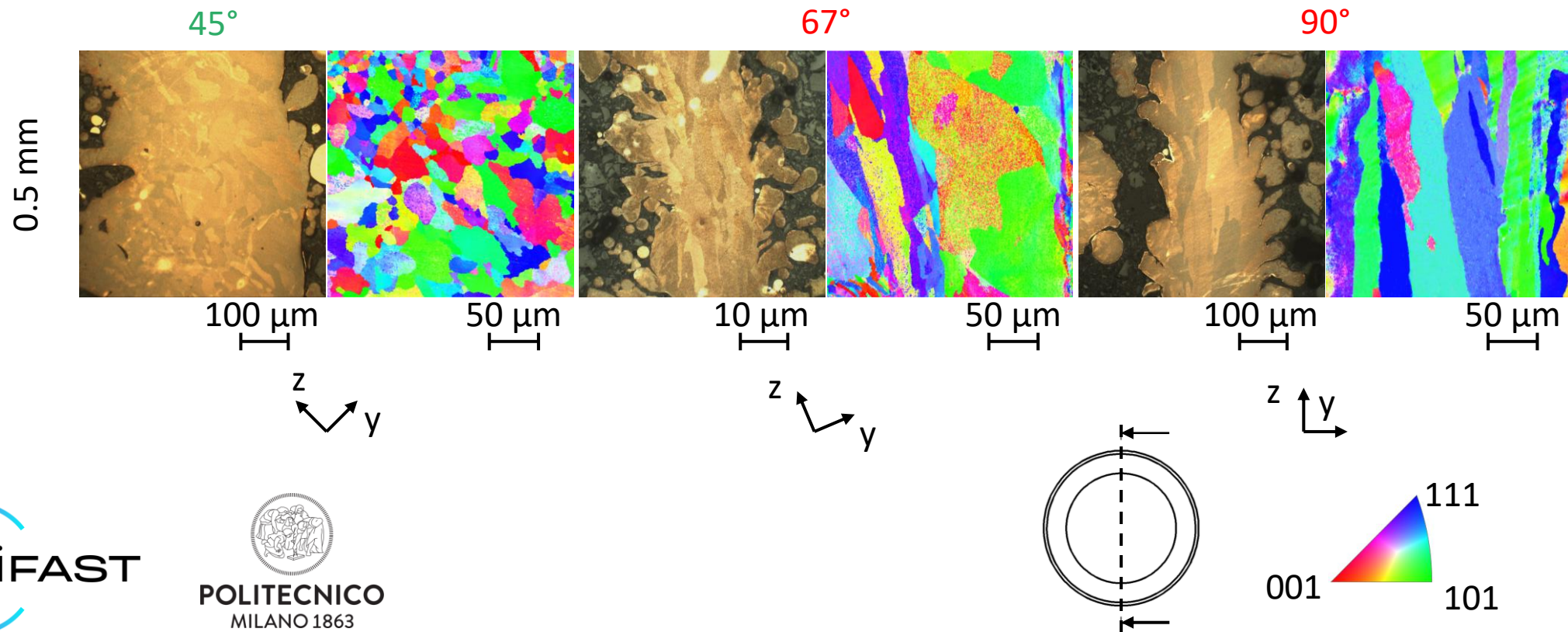


0.5 mm



# UHV tests on Cu printed membranes

- For fine-thickness membranes, building orientation plays a role on grain shape (equiaxed vs. elongated)
- Fine and homogeneous grain structure can reduce the risk of leaks



# Final remarks

- This was not meant to be the final step of our activities for task 10.2
- These running efforts are supporting the definition of the most strategic directions for future research on AM technologies to enhance their impact on accelerator applications
- We are considering them as the starting point for a much longer journey, pushing ahead the current limits of AM for the design of more advanced accelerators

My personal and warmest thanks to the whole team!

# iFAST



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